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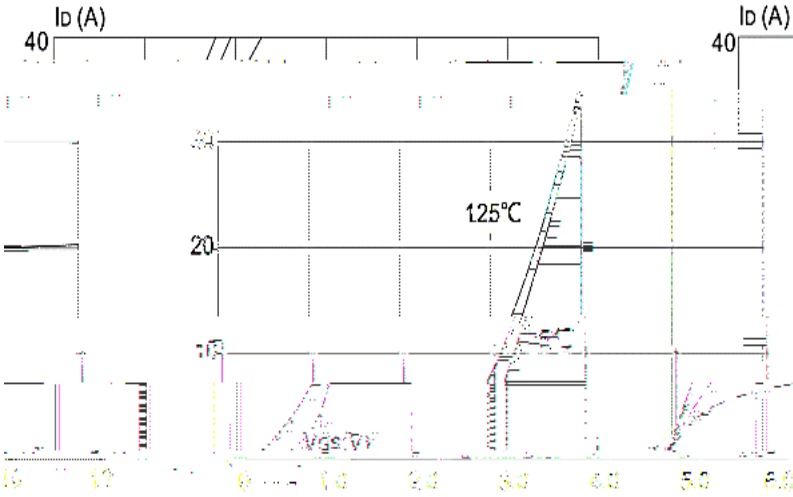

Figure1: Output Characteristics

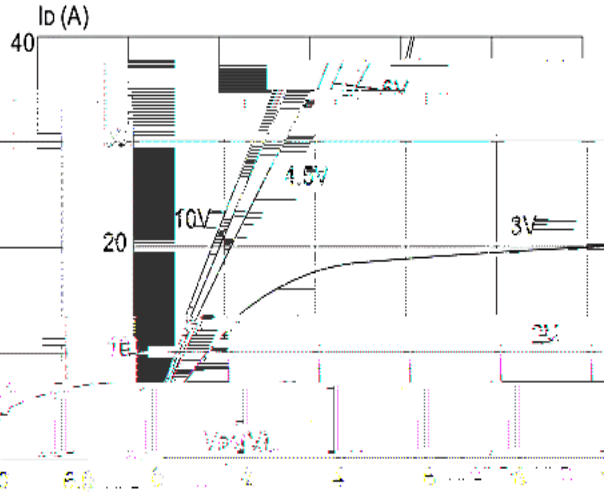

Figure 2: Typical Transfer Characteristics

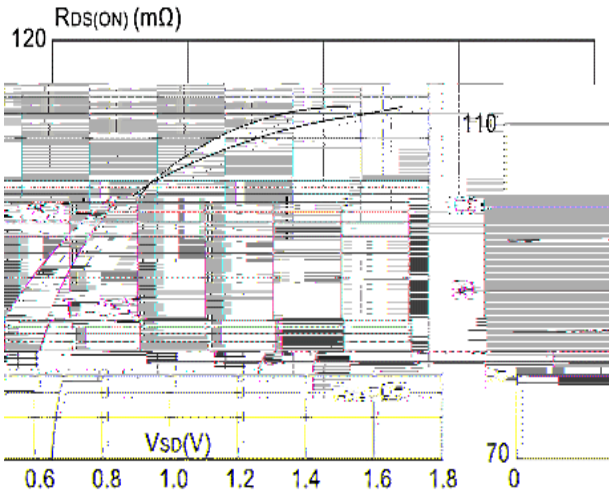

Figure 3:On-resistance vs. Drain Current

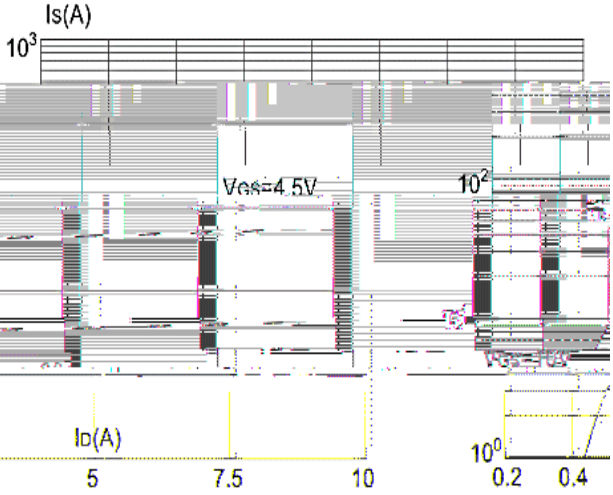

Figure 4: Body Diode Characteristics

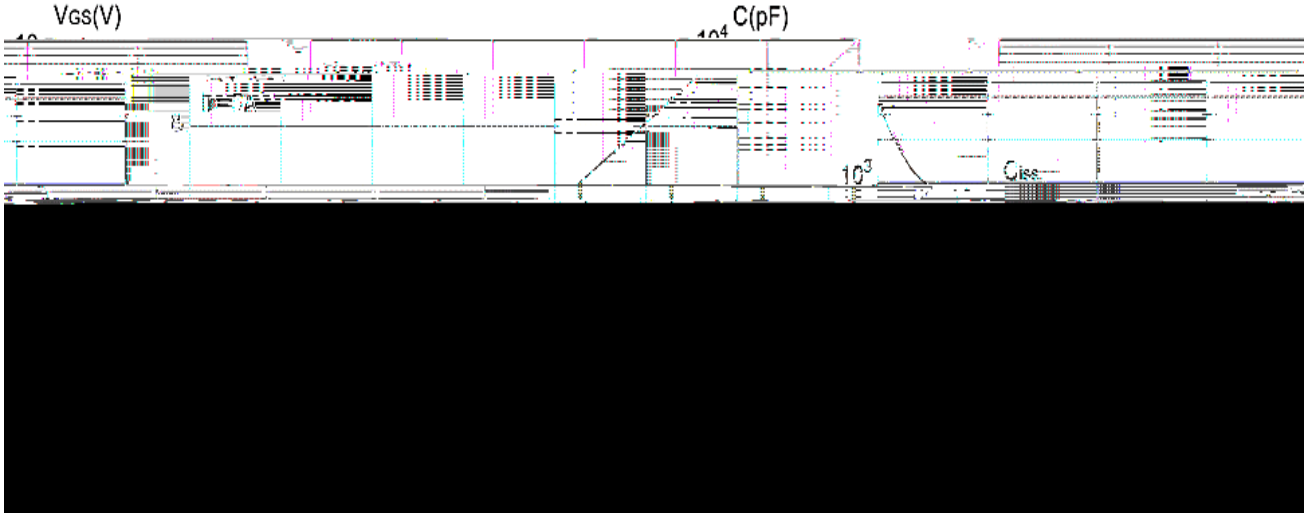

Figure 5: Gate Charge Characteristics

Figure 6: Capacitance Characteristics

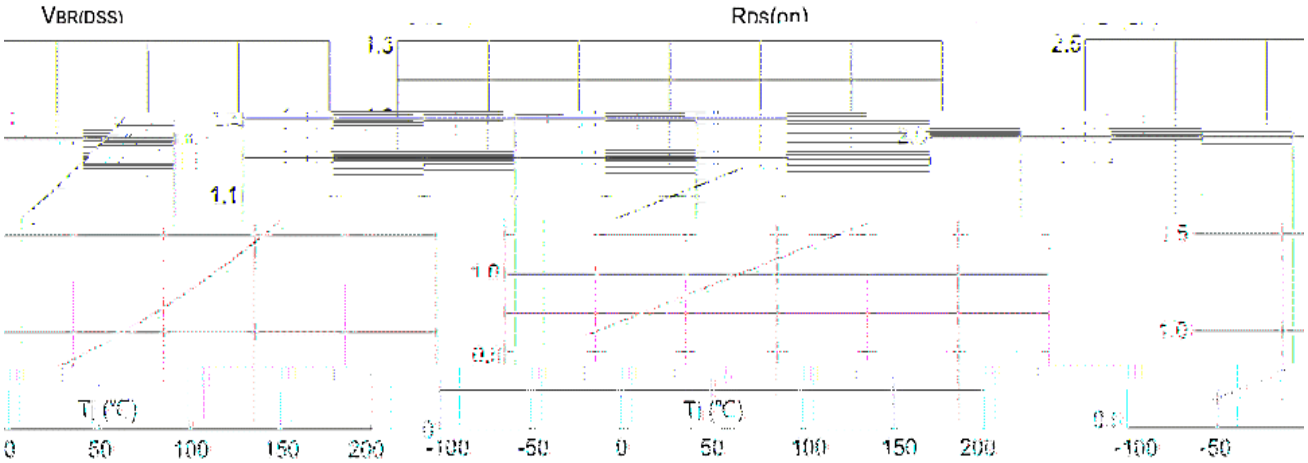

Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

Figure 8: Normalized on Resistance vs. Junction Temperature

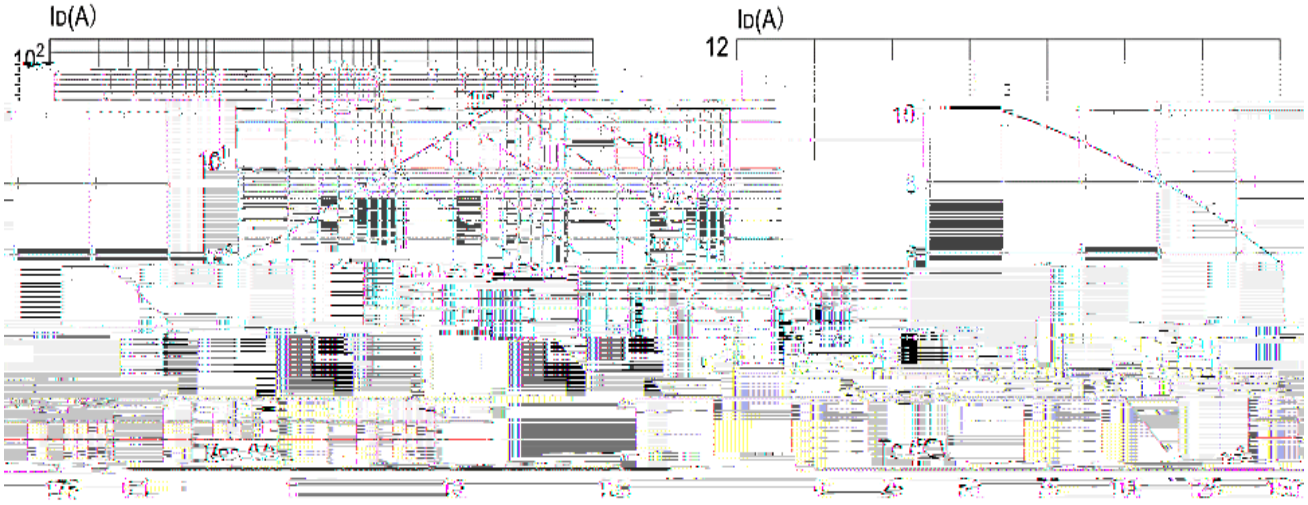

Figure 9: Maximum Safe Operating Area

Figure 10: Maximum Continuous Drain Current vs. Case Temperature

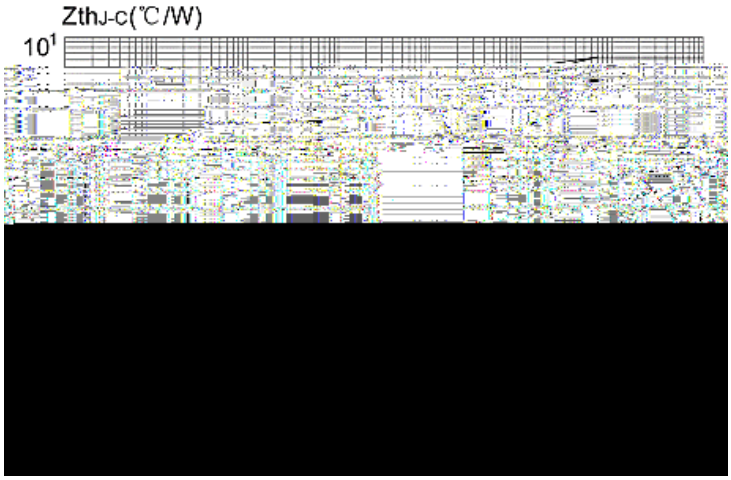

Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

Marking Diagram

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